



## Description

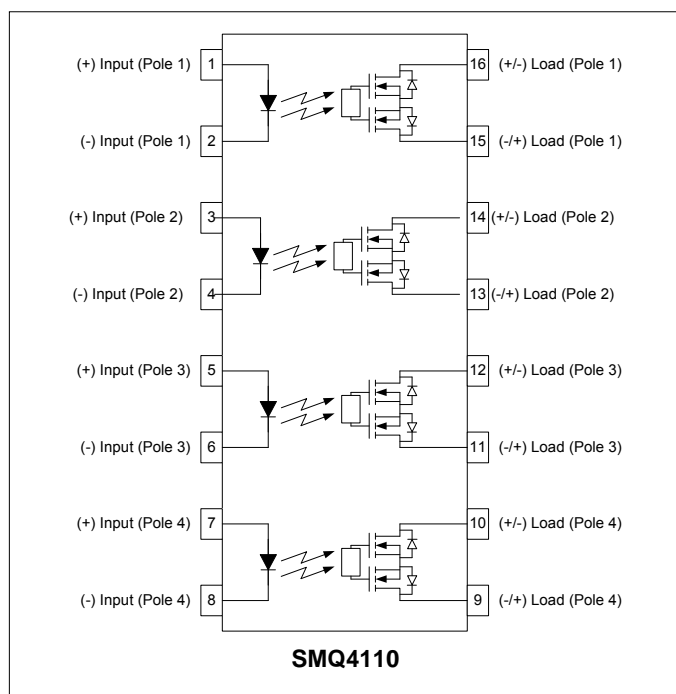
The SMQ4110 is a bi-directional, quad-pole, single-throw, normally open MOSFET output solid-state relay. This device offers four discrete and independently controlled optically isolated SSRs in one miniature 16 pin SOIC package. Each discrete relay consists of an infrared LED, optically coupled to a Photo Diode Array, which in turn drives a pair of back-to-back enhancement MOSFETs. The output structures offer very fast switching speeds (50μS TYP) and very low leakage current (10nA TYP).

The SMQ4110 comes standard in a 16 SOIC package.

## Applications

- Data Acquisition
- Meter Reading Systems
- Medical Equipment
- Battery Monitoring
- Multiplexers

## Schematic Diagram



## Features

- Quad Pole Switching / Small 16 SOIC Package
- Fast Turn On Speed (<50μS TYP)
- Ultra Low Leakage Current (<10nA TYP)
- 40mA Maximum Continuous Load Current
- High Isolation Voltage (2.5kV<sub>RMS</sub>)
- Long Life / High Reliability
- RoHS / Pb-Free / REACH Compliant

## Agency Approvals

UL / C-UL: File # E201932  
VDE: File # 40035191 (EN 60747-5-2)

## Absolute Maximum Ratings

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

Storage Temperature .....-55 to +125°C  
Operating Temperature .....-40 to +85°C  
Continuous Input Current.....40mA  
Transient Input Current.....400mA  
Reverse Input Control Voltage .....5V  
Input Power Dissipation.....70mW  
Total Power Dissipation .....500mW  
Solder Temperature – Wave (10sec).....260°C  
Solder Temperature – IR Reflow (10sec).....260°C

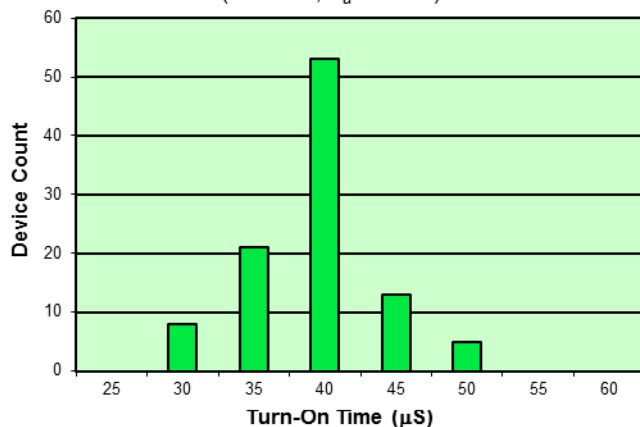
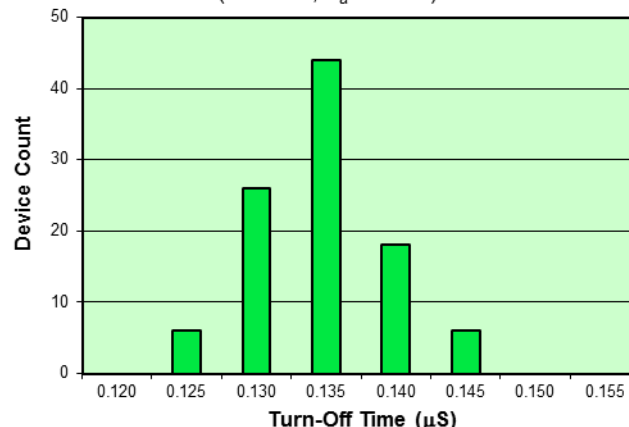
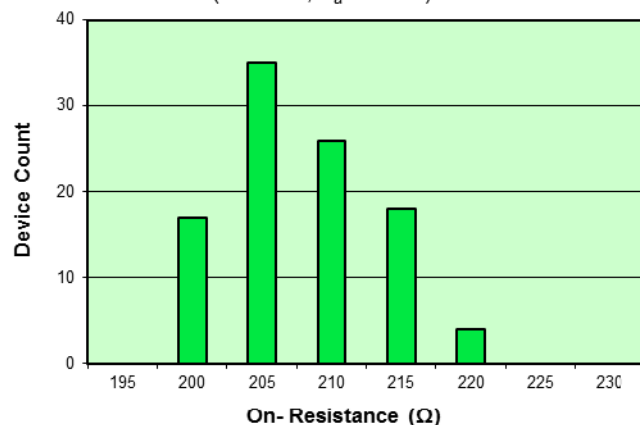
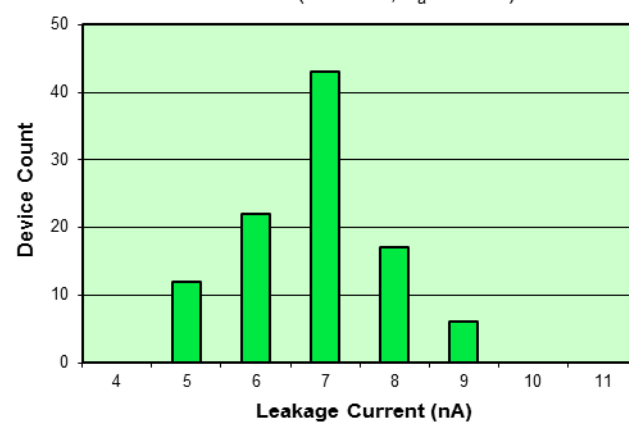
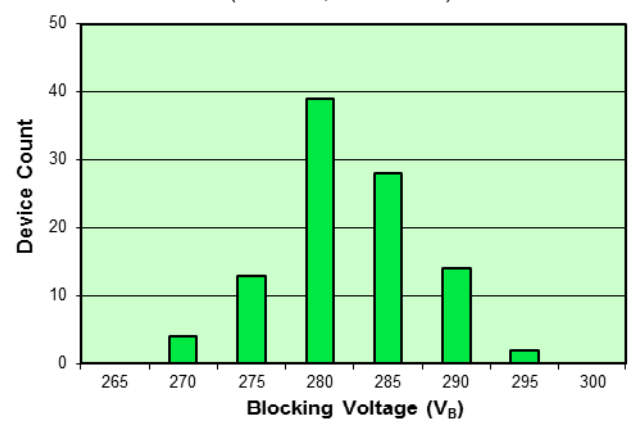
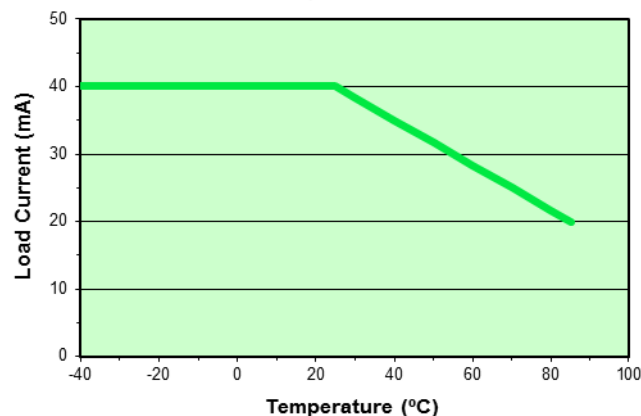
## Ordering Information

Part Number	Description
SMQ4110	16 pin SOIC, (46/Tube)
SMQ4110-TR	16 pin SOIC, Tape and Reel (1000/Reel)

**NOTE:** Suffixes listed above are not included in marking on device for part number identification

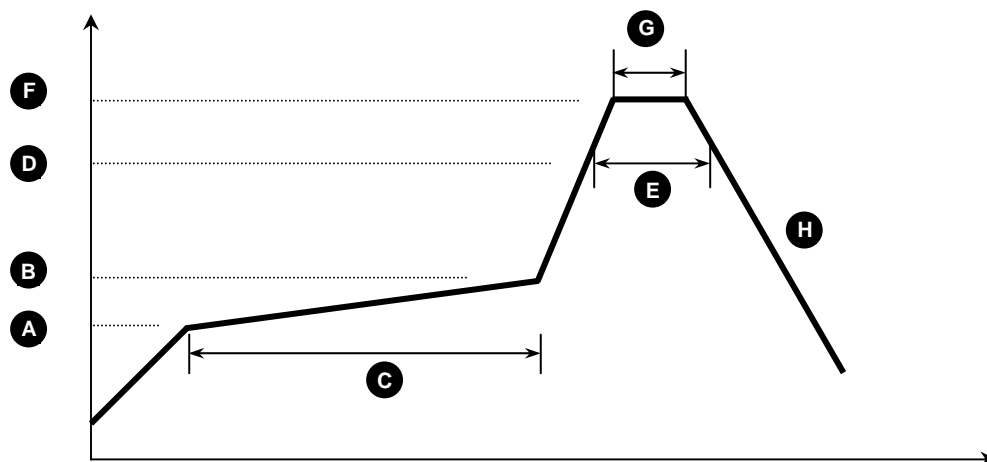
**Electrical Characteristics,  $T_A = 25^\circ\text{C}$  (unless otherwise specified)**

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
<b>Input Specifications</b>						
LED Forward Voltage	$V_F$	-	1.2	1.5	V	$I_F = 10\text{mA}$
LED Reverse Voltage	$BV_R$	5	-	-	V	$I_R = 10\mu\text{A}$
Turn-On Current (LED Trigger)	$I_F$	-	2.5	5	mA	$I_O = 40\text{mA}$
Turn-Off Current	$I_{\text{FOFF}}$	-	0.5	-	mA	$I_O = 40\text{mA}$
Terminal Capacitance	$C_t$	-	30	-	pF	$V=0, f=1\text{MHz}$
<b>Output Specifications</b>						
Blocking Voltage	$V_B$	250	-	-	V	$I_F=0\text{mA}, I_O=1\mu\text{A}$
Continuous Load Current	$I_O$	-	-	40	mA	$I_F=5\text{mA}$
On Resistance	$R_{\text{ON}}$	-	225	300	Ω	$I_F=5\text{mA}, I_O=40\text{mA}$
Leakage Current	$I_{\text{leak}}$	-	10	100	nA	$V_O=250\text{V}$
Output Capacitance	$C_{\text{OUT}}$	-	1.5	-	pF	$I_F=0\text{mA}, f=1.0\text{MHz}$
Offset Voltage	$V_{\text{OFFSET}}$	-	-	0.2	mV	$I_F=5\text{mA}$
<b>Coupled Specifications</b>						
Turn-On Time	$T_{\text{ON}}$	-	50	500	μS	$I_F=5\text{mA}, I_O=40\text{mA}$
Turn-Off Time	$T_{\text{OFF}}$	-	150	500	μS	$I_F=0\text{mA}, I_O=40\text{mA}$
Input to Output Capacitance	$C_S$	-	3	-	pF	$V=0, f=1\text{MHz}$
Contact Transient Ratio	-	2,000	7,000	0	V/μS	$dV = 50\text{V}$
<b>Isolation Specifications</b>						
Isolation Voltage	$V_{\text{ISO}}$	2500	-	-	$V_{\text{RMS}}$	$\text{RH} \leq 50\%, t=1\text{min}$
Input-Output Resistance	$R_{\text{I-O}}$	-	$10^{12}$	-	Ω	$\text{RH} \leq 50\%, V_{\text{I-O}} = 500\text{V}_{\text{DC}}$

**SMQ4110 Performance & Characteristics Plots,  $T_A = 25^\circ\text{C}$  (unless otherwise specified)**
**Figure 1: Typical Turn-On Time Distribution**  
(N = 100,  $T_a = 25^\circ\text{C}$ )

**Figure 2: Typical Turn-Off Time Distribution**  
(N = 100,  $T_a = 25^\circ\text{C}$ )

**Figure 3: Typical On-Resistance Distribution**  
(N = 100,  $T_a = 25^\circ\text{C}$ )

**Figure 4: Typical Output Leakage Current Distribution**  
(N = 100,  $T_a = 25^\circ\text{C}$ )

**Figure 5: Typical Blocking Voltage Distribution**  
(N = 100,  $T_a = 25^\circ\text{C}$ )

**Figure 6: Maximum Load Current vs. Temperature**


**SMQ4110 Solder Reflow Temperature Profile Recommendations**
**(1) Infrared Reflow:**

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250°C:



Process Step	Description	Parameter
A	Preheat Start Temperature (°C)	150°C
B	Preheat Finish Temperature (°C)	180°C
C	Preheat Time (s)	90 - 120s
D	Melting Temperature (°C)	230°C
E	Time above Melting Temperature (s)	30s
F	Peak Temperature, at Terminal (°C)	260°C
G	Dwell Time at Peak Temperature (s)	10s
H	Cool-down (°C/s)	<6°C/s

**(2) Wave Solder:**

Maximum Temperature: 260°C (at terminal)  
Maximum Time: 10s  
Pre-heating: 100 - 150°C (30 - 90s)  
Single Occurrence

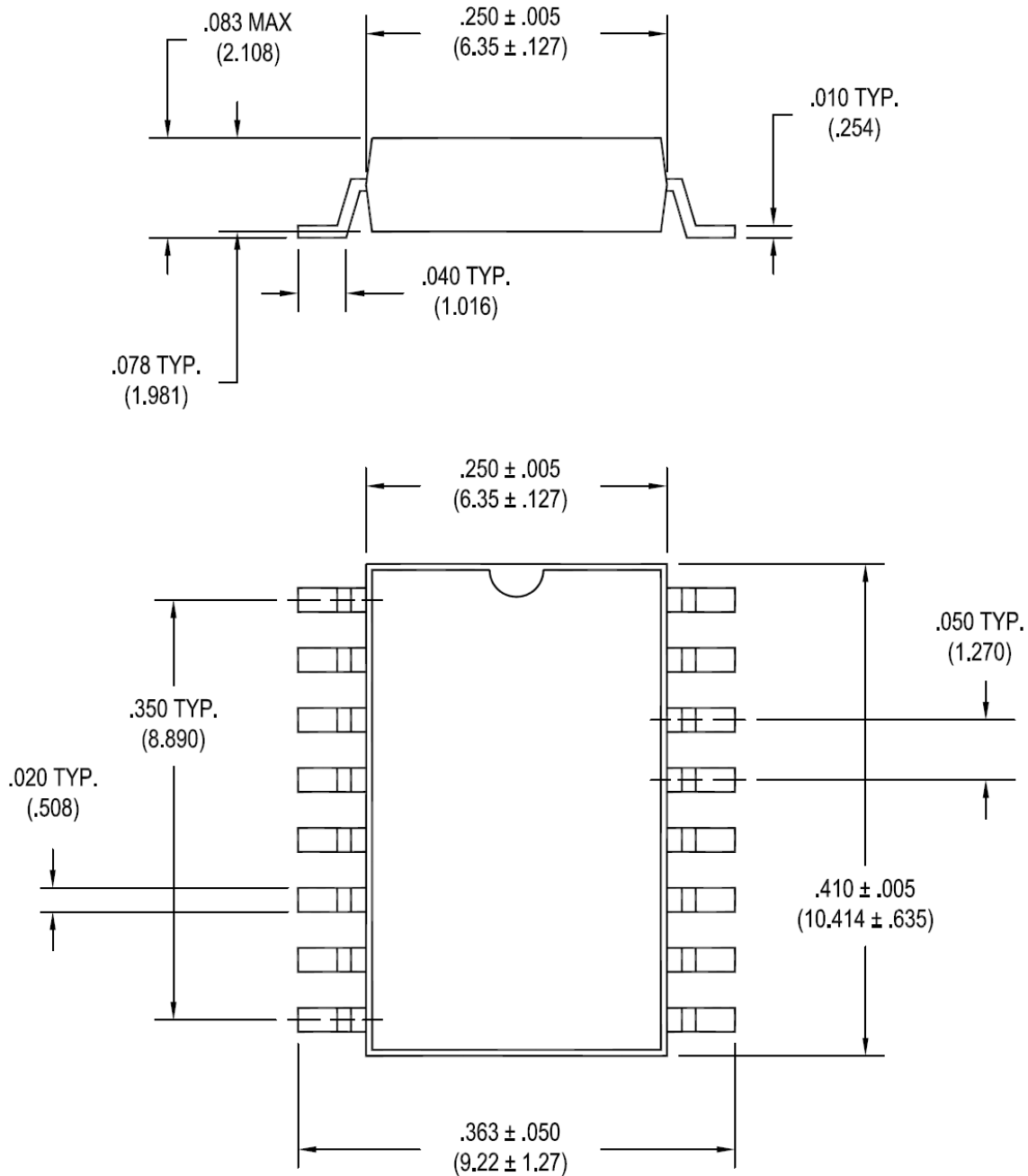
**(3) Hand Solder:**

Maximum Temperature: 350°C (at tip of soldering iron)  
Maximum Time: 3s  
Single Occurrence

**SMQ4110 Package Dimensions**

16 PIN SOIC Package

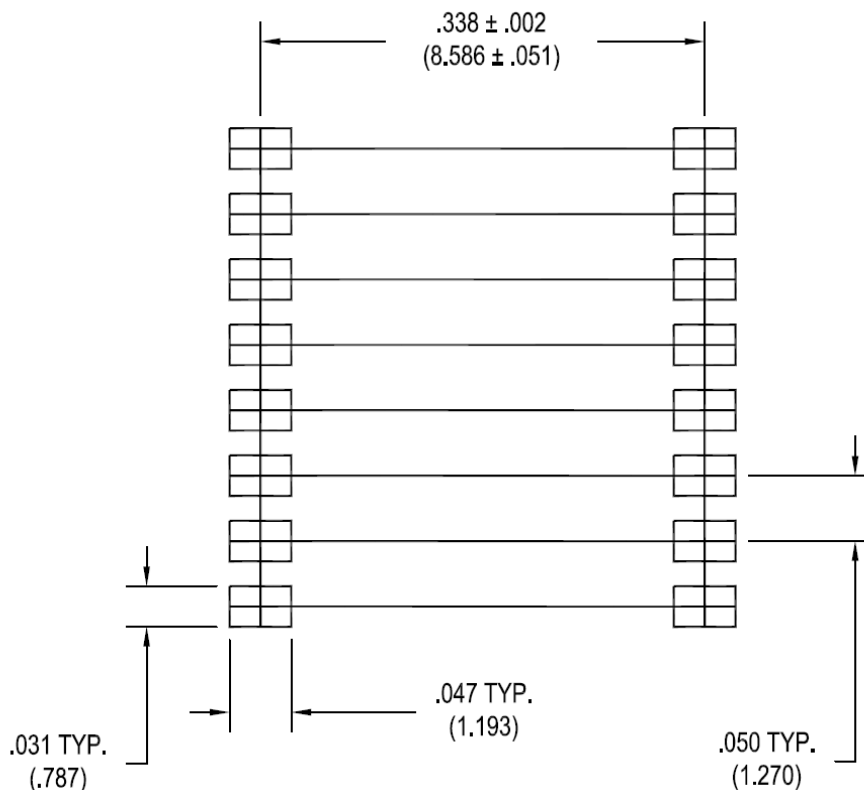
**Note:** All dimensions in inches ["] with millimeters in parenthesis (mm)

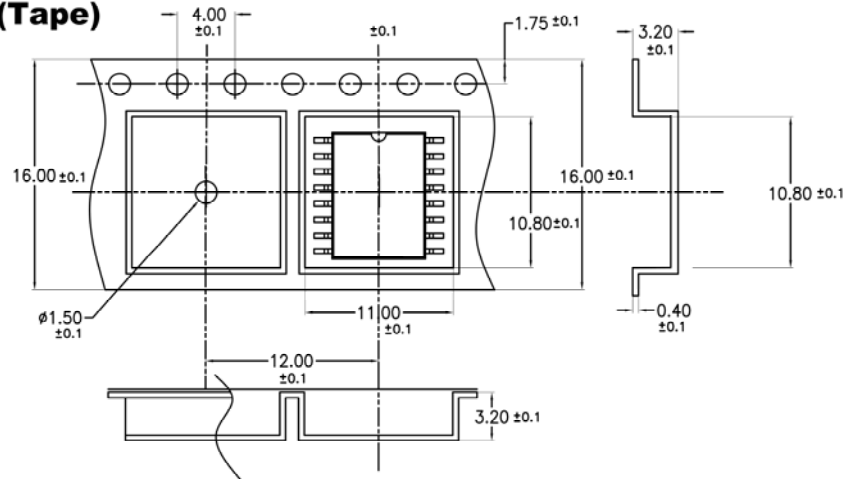
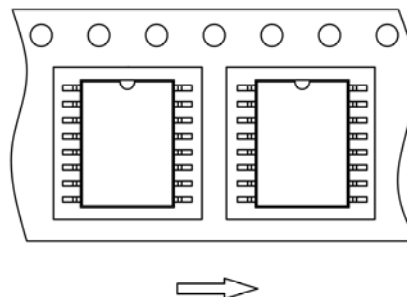
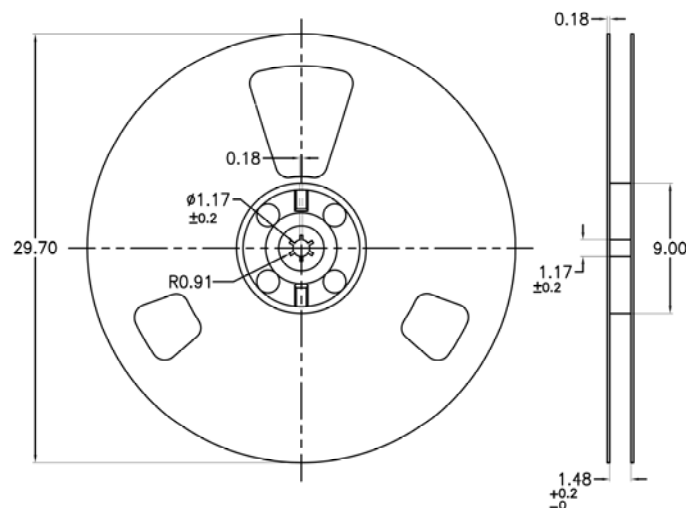


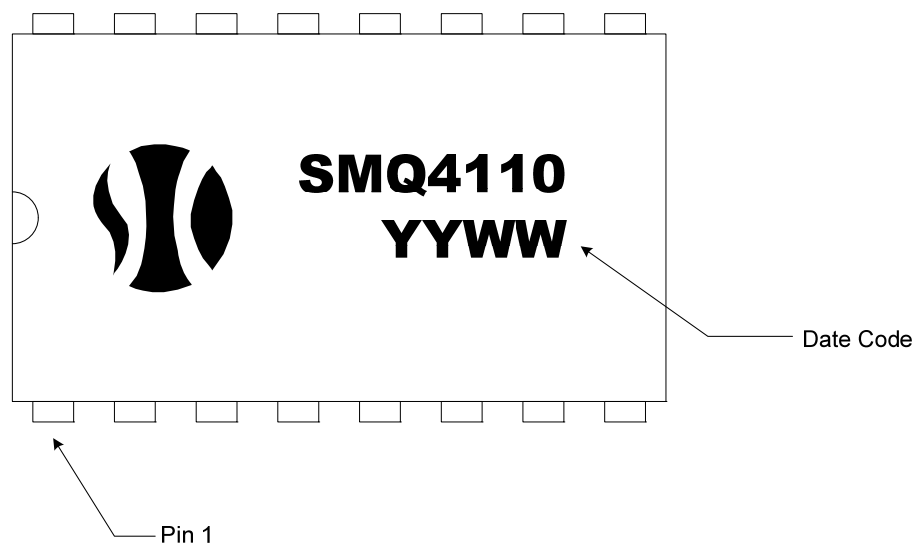
**SMQ4110 Package Dimensions**

16 PIN SOIC Footprint

**Note:** All dimensions in inches ["] with millimeters in parenthesis (mm)



**SMQ4110 Package Dimensions**
**TAPING SPECIFICATIONS (in millimeters)**
**Outline and Dimension (Tape)**

**Parts Orientation and Tape Direction**

**Outline and Dimensions (Reel)**

**Packaging: 1,000 pcs / reel**

**SMQ4110 Package Marking****DISCLAIMER**

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